

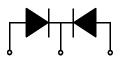
## **Ultrafast Rectifier**

## FFA60UP20DN

### **Features**

- Ultrafast with soft recovery (@ I<sub>F</sub> = 1A), < 40ns</li>
- Reverse Voltage, 200V
- Forward Voltage (@  $T_C = 100^{\circ}C$ ), < 1V





### 1. Anode 2.Cathode 3. Anode

## **Applications**

- Power switching circuits
- Output rectifiers
- · Freewheeling diodes
- · Switching mode power supply

### Absolute Maximum Ratings (per diode) T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	200	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 100°C	30	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	300	А
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	1.4	°C/W

## Electrical Characteristics (per diode) T<sub>C</sub>=25 °C unless otherwise noted

Symbol	Parameter			Тур.	Max.	Units
V <sub>FM</sub> *	Maximum Instantaneous Forward Voltage					V
	$I_F = 30A$	T <sub>C</sub> = 25 °C	-	-	1.15	
	I <sub>F</sub> = 30A	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	-	-	1.0	
I <sub>RM</sub> *	Maximum Instantaneous Reverse Current					μΑ
	@ rated V <sub>R</sub>	$T_C = 25$ °C $T_C = 100$ °C	-	-	10	
		T <sub>C</sub> = 100 °C	-	-	100	
t <sub>rr</sub>	Reverse Recovery Time		-	32	-	ns
I <sub>rr</sub>	Reverse Recovery Current		-	2.4	-	Α
$Q_{rr}$	Reverse Recovery Charge		-	38.4	-	nC
	$(I_F = 30A, di/dt = 200A/\mu s)$					
t <sub>rr</sub>	Maximum Reverse Recovery Time		-	-	40	ns
	$(I_F = 1A, di/dt = 100A/\mu s)$					
W <sub>AVL</sub>	Avalanche Energy (L=40mH)		2	-	-	mJ

<sup>\*</sup> Pulse Test: Pulse Width=300µs, Duty Cycle=2%

## **Typical Characteristics**

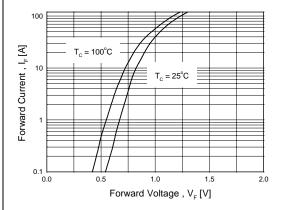


Figure 1. Typical Forward Voltage Drop vs. Forward Current

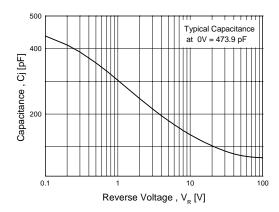


Figure 3. Typical Junction Capacitance

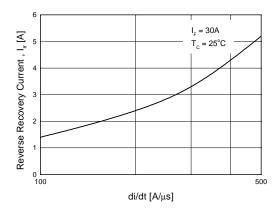


Figure 5. Typical Reverse Recovery Current vs. di/dt

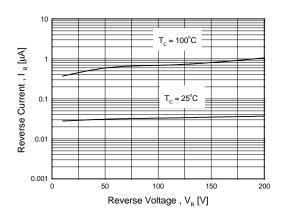


Figure 2. Typical Reverse Current vs. Reverse Voltage

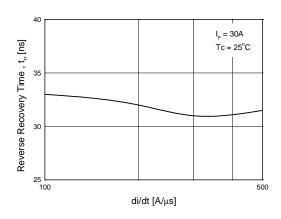


Figure 4. Typical Reverse Recovery Time vs. di/dt

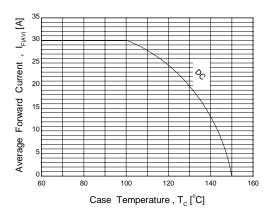
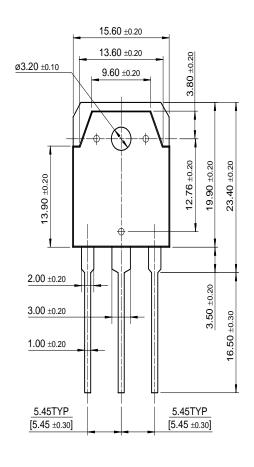
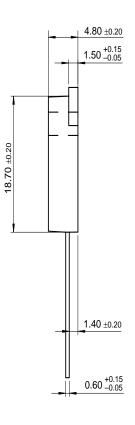


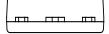
Figure 6. Forward Current Derating Curve

# **Package Dimensions**

## TO-3P







Dimensions in Millimeters

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E <sup>2</sup> CMOS™	I <sup>2</sup> C™	MSXPro™	RapidConfigure™	TruTranslation™
EnSigna™	i-Lo™	OCXTM	RapidConnect™	UHC™
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FACT Quiet Series™		OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	VCX™
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The Power Franchise <sup>®</sup>		PACMAN™	SPM™	
Programmable Active Droop™		POP™	Stealth™	

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